

## N-Channel Super Junction Power MOSFET

### General Description

The series of devices use advanced super junction technology and design to provide excellent  $R_{DS(ON)}$  with low gate charge. This super junction MOSFET fits the industry's AC-DC SMPS requirements for PFC, AC/DC power conversion, and industrial power applications.

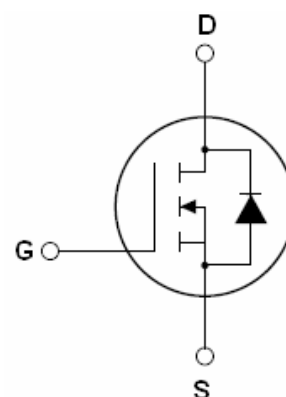
### Features

- New technology for high voltage device
- Low on-resistance and low conduction losses
- Ultra Low Gate Charge cause lower driving requirements
- 100% Avalanche Tested
- ROHS compliant

### Application

- Power factor correction (PFC)
- Switched mode power supplies(SMPS)
- Uninterruptible Power Supply (UPS)

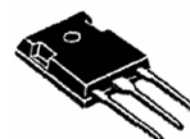
|                   |     |    |
|-------------------|-----|----|
| $V_{DS@T_{jmax}}$ | 650 | V  |
| $R_{DS(ON)}$      | 190 | mΩ |
| $I_D$             | 20  | A  |



Schematic diagram

### Package Marking And Ordering Information

| Device      | Device Package | Marking     |
|-------------|----------------|-------------|
| FNKS20N60FL | TO-247         | FNKS20N60FL |



TO-247

Table 1. Absolute Maximum Ratings ( $T_c=25^\circ\text{C}$ )

| Parameter   | Symbol          | NCE20N60T | Unit                |
|---|-----------------|-----------|---------------------|
| Drain-Source Voltage ( $V_{GS}=0V$ )  | $V_{DS}$        | 600       | V                   |
| Gate-Source Voltage ( $V_{DS}=0V$ )   | $V_{GS}$        | $\pm 30$  | V                   |
| Continuous Drain Current at $T_c=25^\circ\text{C}$  | $I_{D(DC)}$     | 20        | A                   |
| Continuous Drain Current at $T_c=100^\circ\text{C}$   | $I_{D(DC)}$     | 12.5      | A                   |
| Pulsed drain current (Note 1)   | $I_{DM(pluse)}$ | 60        | A                   |
| Drain Source voltage slope, $V_{DS} = 480\text{ V}$ , $I_D = 20\text{ A}$ , $T_j = 125^\circ\text{C}$ | dv/dt           | 50        | V/ns                |
| Maximum Power Dissipation( $T_c=25^\circ\text{C}$ )   | $P_D$           | 208       | W                   |
| Derate above $25^\circ\text{C}$   |                 | 1.67      | W/ $^\circ\text{C}$ |
| Single pulse avalanche energy (Note 2)  | $E_{AS}$        | 690       | mJ                  |
| Avalanche current (Note 1)  | $I_{AR}$        | 20        | A                   |

| Parameter   | Symbol         | NCE20N60T  | Unit |
|---|----------------|------------|------|
| Repetitive Avalanche energy , $t_{AR}$ limited by $T_{jmax}$ (Note 1) | $E_{AR}$       | 1          | mJ   |
| Operating Junction and Storage Temperature Range                      | $T_J, T_{STG}$ | -55...+150 | °C   |

\* limited by maximum junction temperature

**Table 2. Thermal Characteristic**

| Parameter   | Symbol     | NCE20N60T | Unit  |
|---|------------|-----------|-------|
| Thermal Resistance, Junction-to-Case (Maximum)    | $R_{thJC}$ | 0.6       | °C /W |
| Thermal Resistance, Junction-to-Ambient (Maximum) | $R_{thJA}$ | 62        | °C /W |

**Table 3. Electrical Characteristics (TA=25°C unless otherwise noted)**

| Parameter  | Symbol       | Condition  | Min | Typ  | Max       | Unit       |         |
|--|--------------|--|-----|------|-----------|------------|---------|
| <b>On/off states</b>                                 |              |  |     |      |           |            |         |
| Drain-Source Breakdown Voltage                       | $BV_{DSS}$   | $V_{GS}=0V, I_D=250\mu A$                              | 600 |      |           | V          |         |
| Zero Gate Voltage Drain Current( $T_c=25^\circ C$ )  | $I_{DSS}$    | $V_{DS}=600V, V_{GS}=0V$                               |     | 0.05 | 1         | $\mu A$    |         |
| Zero Gate Voltage Drain Current( $T_c=125^\circ C$ ) | $I_{DSS}$    | $V_{DS}=600V, V_{GS}=0V$                               |     |      | 100       | $\mu A$    |         |
| Gate-Body Leakage Current                            | $I_{GSS}$    | $V_{GS}=\pm 30V, V_{DS}=0V$                            |     |      | $\pm 100$ | nA         |         |
| Gate Threshold Voltage                               | $V_{GS(th)}$ | $V_{DS}=V_{GS}, I_D=250\mu A$                          | 2.5 | 3    | 3.5       | V          |         |
| Drain-Source On-State Resistance                     | $R_{DS(ON)}$ | $V_{GS}=10V, I_D=10A$                                  |     | 155  | 190       | m $\Omega$ |         |
| <b>Dynamic Characteristics</b>                       |              |  |     |      |           |            |         |
| Forward Transconductance                             | $g_{FS}$     | $V_{DS} = 20V, I_D = 10A$                              |     | 17.5 |           | S          |         |
| Input Capacitance                                    | $C_{ISS}$    | $V_{DS}=50V, V_{GS}=0V,$<br>$F=1.0MHz$                 |     | 2400 |           | pF         |         |
| Output Capacitance                                   | $C_{OSS}$    |  |     | 180  |           | pF         |         |
| Reverse Transfer Capacitance                         | $C_{RSS}$    |  |     | 5.7  |           | pF         |         |
| Total Gate Charge                                    | $Q_g$        | $V_{DS}=480V, I_D=20A,$<br>$V_{GS}=10V$                |     | 55   | 114       | nC         |         |
| Gate-Source Charge                                   | $Q_{gs}$     |  |     | 11   |           | nC         |         |
| Gate-Drain Charge                                    | $Q_{gd}$     |  |     | 22   |           | nC         |         |
| Intrinsic gate resistance                            | $R_G$        | $f = 1 MHz$ open drain                                 |     | 0.9  |           | $\Omega$   |         |
| <b>Switching times</b>                               |              |  |     |      |           |            |         |
| Turn-on Delay Time                                   | $t_{d(on)}$  | $V_{DD}=380V, I_D=20A,$<br>$R_G=3.6\Omega, V_{GS}=10V$ |     | 10   |           | nS         |         |
| Turn-on Rise Time                                    | $t_r$        |  |     | 5    |           | nS         |         |
| Turn-Off Delay Time                                  | $t_{d(off)}$ |  |     | 67   | 100       | nS         |         |
| Turn-Off Fall Time                                   | $t_f$        |  |     | 4    | 12        | nS         |         |
| <b>Source- Drain Diode Characteristics</b>           |              |  |     |      |           |            |         |
| Source-drain current(Body Diode)                     | $I_{SD}$     | $T_C=25^\circ C$                                       |     |      | 20        | A          |         |
| Pulsed Source-drain current(Body Diode)              | $I_{SDM}$    |  |     |      | 60        | A          |         |
| Forward on voltage                                   | $V_{SD}$     | $T_J=25^\circ C, I_{SD}=20A, V_{GS}=0V$                |     | 0.9  | 1.3       | V          |         |
| Reverse Recovery Time                                | $t_{rr}$     | $T_J=25^\circ C, I_F=20A, di/dt=100A/\mu s$            |     | 360  |           | nS         |         |
| Reverse Recovery Charge                              | $Q_{rr}$     |  |     |      | 5.5       |            | $\mu C$ |
| Peak Reverse Recovery Current                        | $I_{rrm}$    |  |     |      | 30        |            | A       |

Notes 1.Repetitive Rating: Pulse width limited by maximum junction temperature

2.  $T_J=25^\circ C, V_{DD}=50V, V_G=10V, R_G=25\Omega$

## TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS (curves)

Figure1. Safe operating area for NCE20N60T

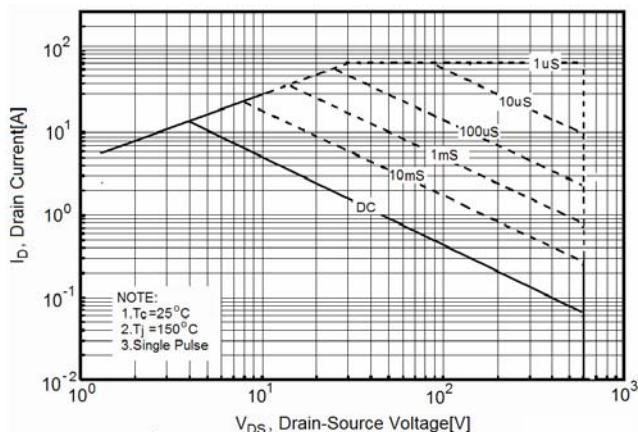


Figure2. Source-Drain Diode Forward Voltage

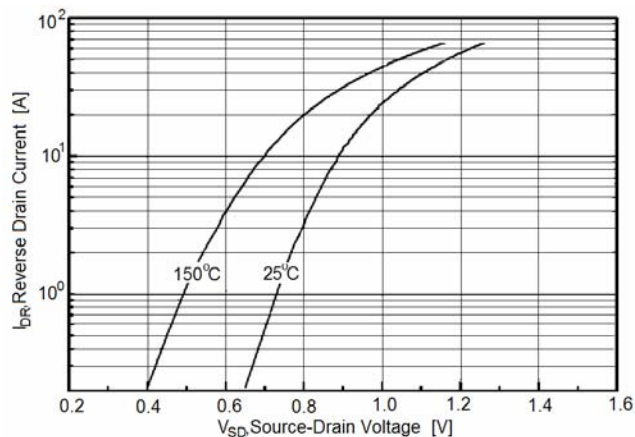


Figure3. Output characteristics

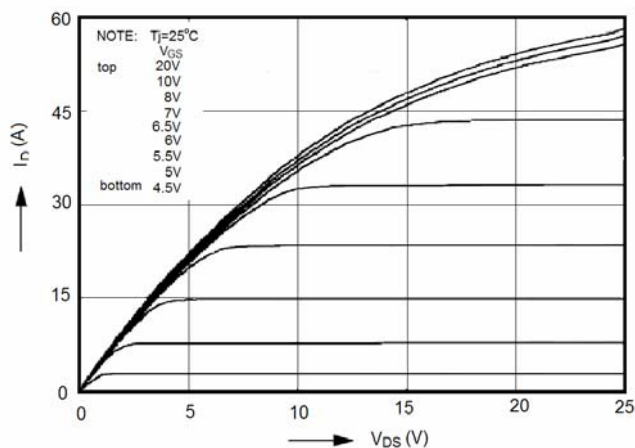


Figure4. Transfer characteristics

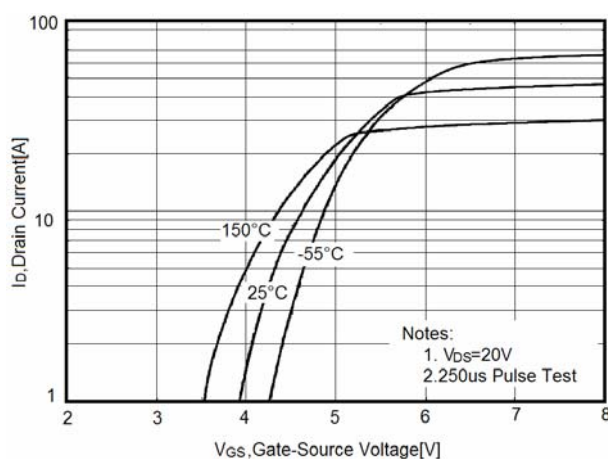


Figure5. Static drain-source on resistance

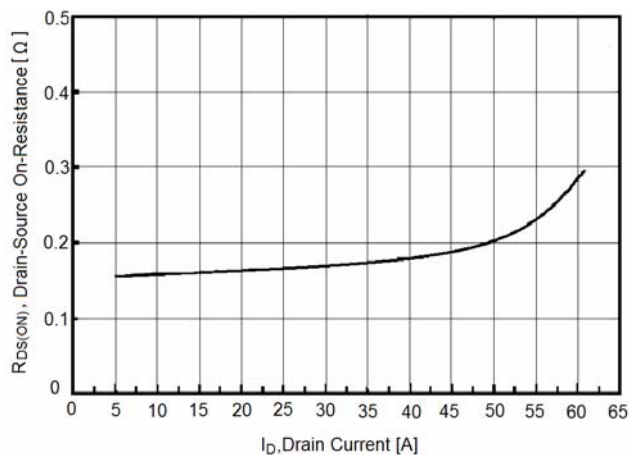
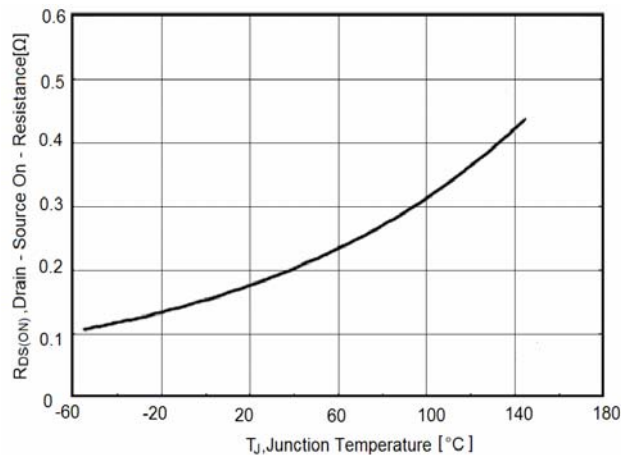
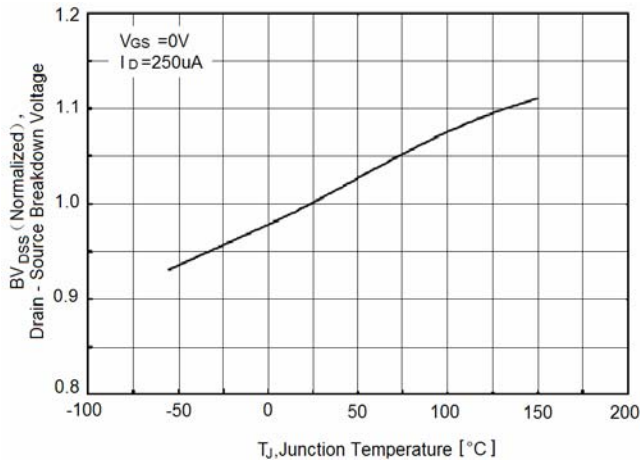


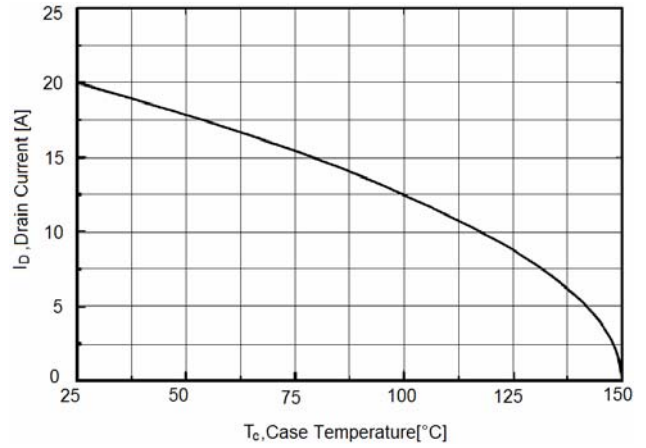
Figure6.  $R_{DS(ON)}$  vs Junction Temperature



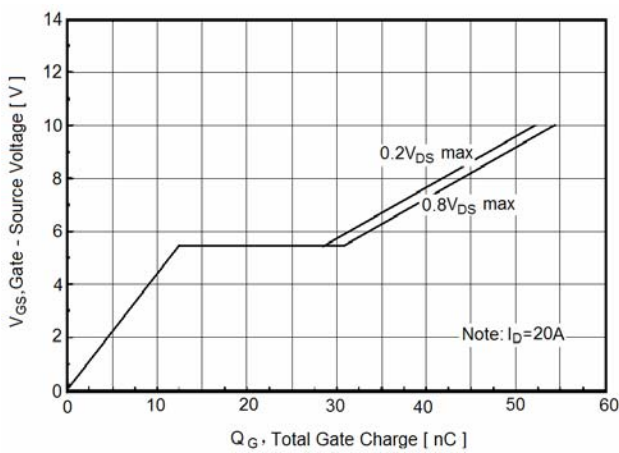
**Figure7.  $BV_{DSS}$  vs Junction Temperature**



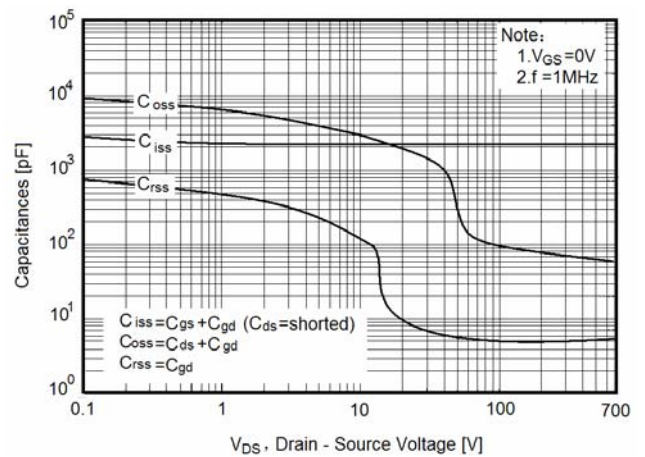
**Figure8. Maximum  $I_D$  vs Junction Temperature**



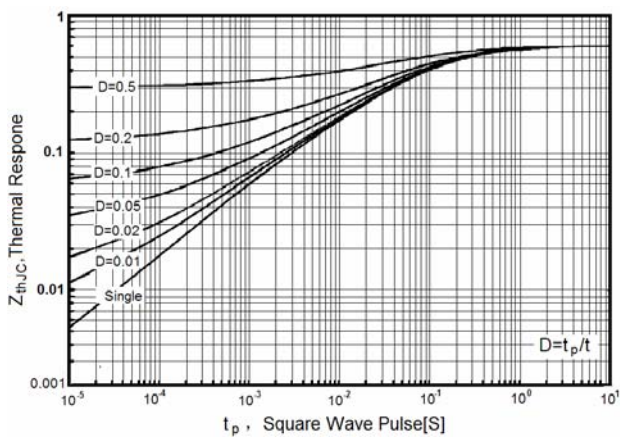
**Figure9. Gate charge waveforms**



**Figure10. Capacitance**

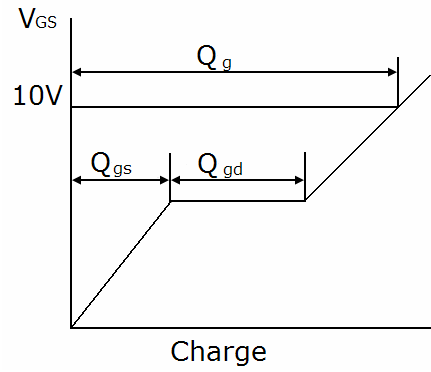
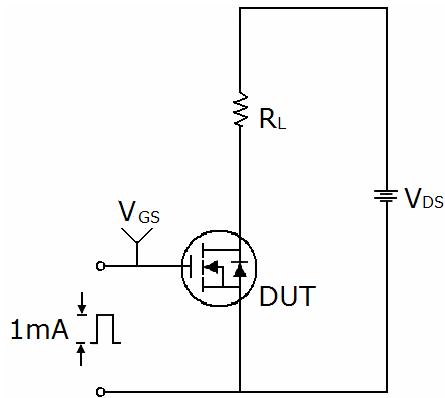


**Figure11. Transient Thermal Impedance**

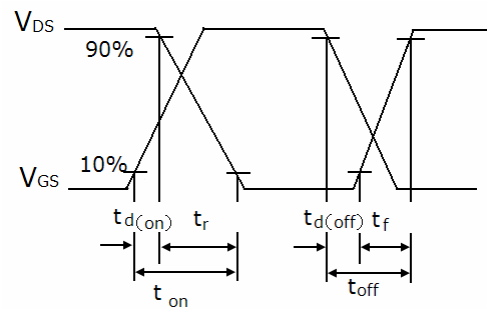
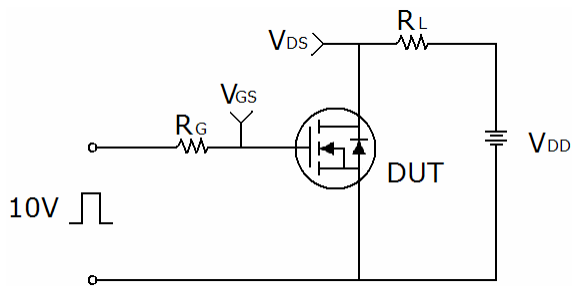


## Test circuit

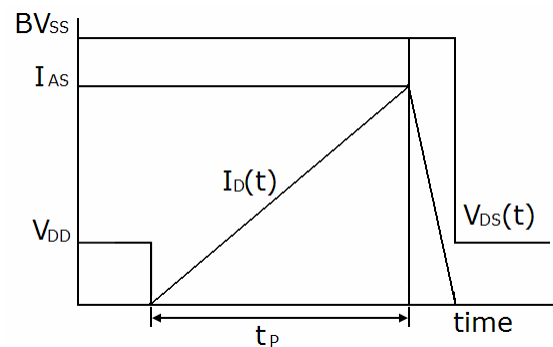
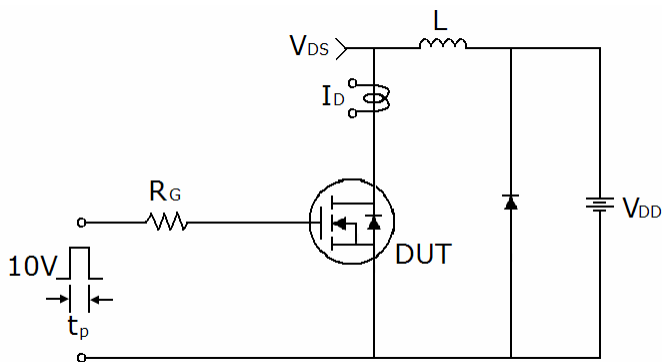
### 1) Gate charge test circuit & Waveform



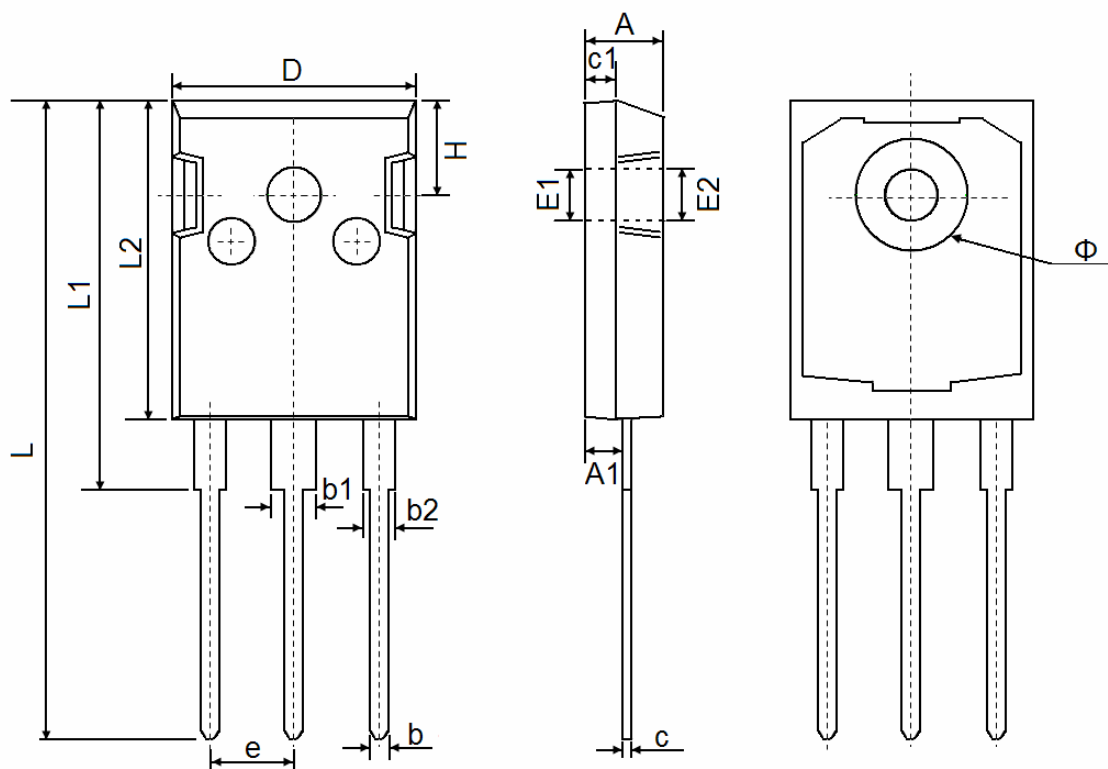
### 2) Switch Time Test Circuit:



### 3) Unclamped Inductive Switching Test Circuit & Waveforms



## TO-247 Package Information



| Symbol | Dimensions In Millimeters |        | Dimensions In Inches |       |
|--------|---------------------------|--------|----------------------|-------|
|        | Min.                      | Max.   | Min.                 | Max.  |
| A      | 4.850                     | 5.150  | 0.191                | 0.200 |
| A1     | 2.200                     | 2.600  | 0.087                | 0.102 |
| b      | 1.000                     | 1.400  | 0.039                | 0.055 |
| b1     | 2.800                     | 3.200  | 0.110                | 0.126 |
| b2     | 1.800                     | 2.200  | 0.071                | 0.087 |
| c      | 0.500                     | 0.700  | 0.020                | 0.028 |
| c1     | 1.900                     | 2.100  | 0.075                | 0.083 |
| D      | 15.450                    | 15.750 | 0.608                | 0.620 |
| E1     | 3.500 REF                 |        | 0.138 REF            |       |
| E2     | 3.600 REF                 |        | 0.142 REF            |       |
| L      | 40.900                    | 41.300 | 1.610                | 1.626 |
| L1     | 24.800                    | 25.100 | 0.976                | 0.988 |
| L2     | 20.300                    | 20.600 | 0.799                | 0.811 |
| Φ      | 7.100                     | 7.300  | 0.280                | 0.287 |
| e      | 5.450 TYP                 |        | 0.215 TYP            |       |
| H      | 5.980 REF                 |        | 0.235 REF            |       |